# **SKKE 212/16 H2**



# SEMIPACK® 2

### **Rectifier Diode Modules**

#### **SKKE 212/16 H2**

#### Features\*

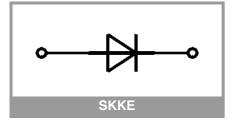
- Heat transfer through aluminum oxide ceramic insulated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E63532

### **Typical Applications**

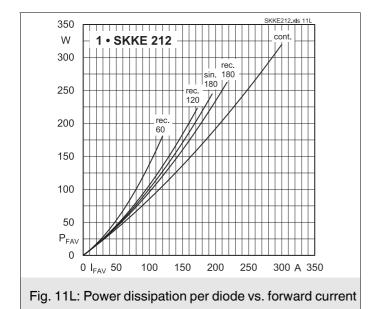
- Rectifiers
- · Free-wheeling diodes
- Reverse-polarity protection

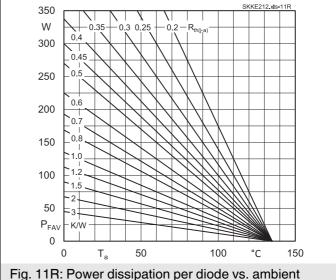
| Absolute Maximum Ratings |  |                         |          |                  |  |  |  |  |  |
|--------------------------|--|-------------------------|----------|------------------|--|--|--|--|--|
| Symbol                   | Conditions                               |                         | Values   | Unit             |  |  |  |  |  |
| Recitifier               | Diode                                    |                         |          | '                |  |  |  |  |  |
| I <sub>FAV</sub>         | sin. 180°<br>T <sub>j max</sub> = 135 °C | T <sub>c</sub> = 85 °C  | 213      | Α                |  |  |  |  |  |
|                          |  | T <sub>c</sub> = 100 °C | 165      | Α                |  |  |  |  |  |
| I <sub>FSM</sub>         | 10 ms                                    | T <sub>j</sub> = 25 °C  | 6600     | А                |  |  |  |  |  |
|                          |  | T <sub>j</sub> = 135 °C | 5500     | Α                |  |  |  |  |  |
| i <sup>2</sup> t         | 10 ms                                    | T <sub>j</sub> = 25 °C  | 217800   | A <sup>2</sup> s |  |  |  |  |  |
|                          |  | T <sub>j</sub> = 135 °C | 151250   | A <sup>2</sup> s |  |  |  |  |  |
| $V_{RSM}$                | T <sub>j</sub> = 25 °C                   | 1                       | 1700     |                  |  |  |  |  |  |
| $V_{RRM}$                | T <sub>j</sub> = 25 °C                   |                         | 1600     | V                |  |  |  |  |  |
| Tj                       |  |                         | -40 135  | °C               |  |  |  |  |  |
| Module                   | •  |                         | <u> </u> | •                |  |  |  |  |  |
| T <sub>stg</sub>         |  |                         | -40 125  | °C               |  |  |  |  |  |
| V <sub>isol</sub>        | a.c.; 50 Hz; r.m.s.                      | 1 min                   | 3000     | V                |  |  |  |  |  |
|                          |  | 1 s                     | 3600     | V                |  |  |  |  |  |

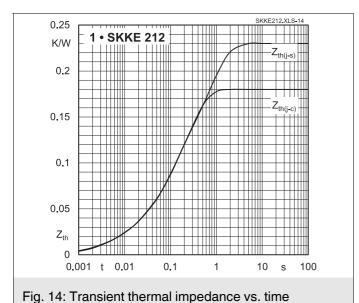
| Characte             | eristics  |            |      |      |          |      |
|----------------------|---|------------|------|------|----------|------|
| Symbol               | Conditions                                      | min.       | typ. | max. | Unit     |      |
| Diode                | •   |            |      |      |          |      |
| V <sub>F</sub>       | $T_j = 25 ^{\circ}\text{C}, I_F = 500 \text{A}$ |            |      |      | 1.40     | V    |
| $V_{F0}$             | T <sub>j</sub> = 135 °C                         |            |      |      | 0.75     | V    |
| r <sub>F</sub>       | T <sub>j</sub> = 135 °C                         |            |      |      | 1.05     | mΩ   |
| I <sub>R</sub>       | $T_j = 135$ °C, $V_{RD} = V_{RRM}$              |            |      |      | 9        | mA   |
| $R_{\text{th(j-c)}}$ | cont.   | per chip   |      |      | 0.18     | K/W  |
|                      |   | per module |      |      | 0.18     | K/W  |
| R <sub>th(j-c)</sub> | sin. 180°                                       | per chip   |      |      | 0.18     | K/W  |
|                      |   | per module |      |      | 0.18     | K/W  |
| Module               |   |            |      |      |          |      |
| $R_{\text{th(c-s)}}$ | chip  |            |      | 0.05 |          | K/W  |
|                      | module  |            |      | 0.05 |          | K/W  |
| Ms                   | to heatsink M5                                  |            | 4.25 |      | 5.75     | Nm   |
| $M_{t}$              | to terminals M6                                 |            | 4.25 |      | 5.75     | Nm   |
| а                    |   |            |      |      | 5 * 9.81 | m/s² |
| w                    |   |            |      | 165  |          | g    |

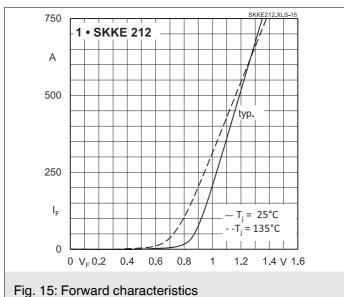


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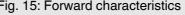




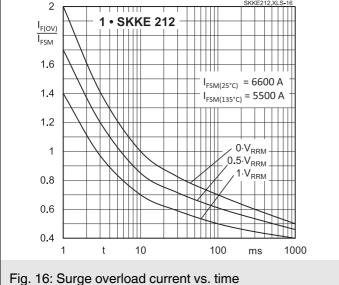




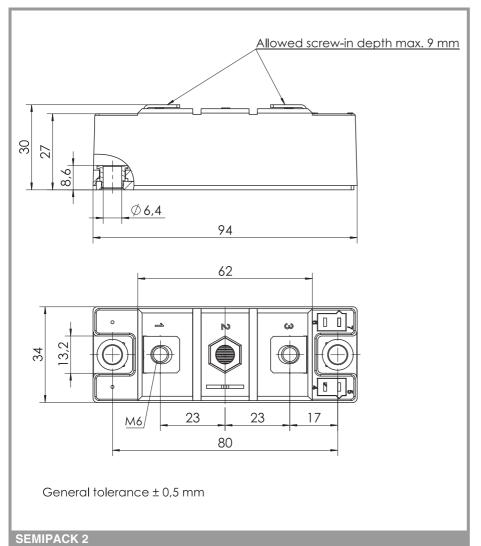


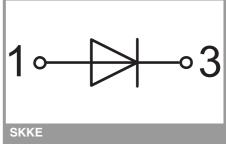


temperature



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This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

#### \*IMPORTANT INFORMATION AND WARNINGS

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